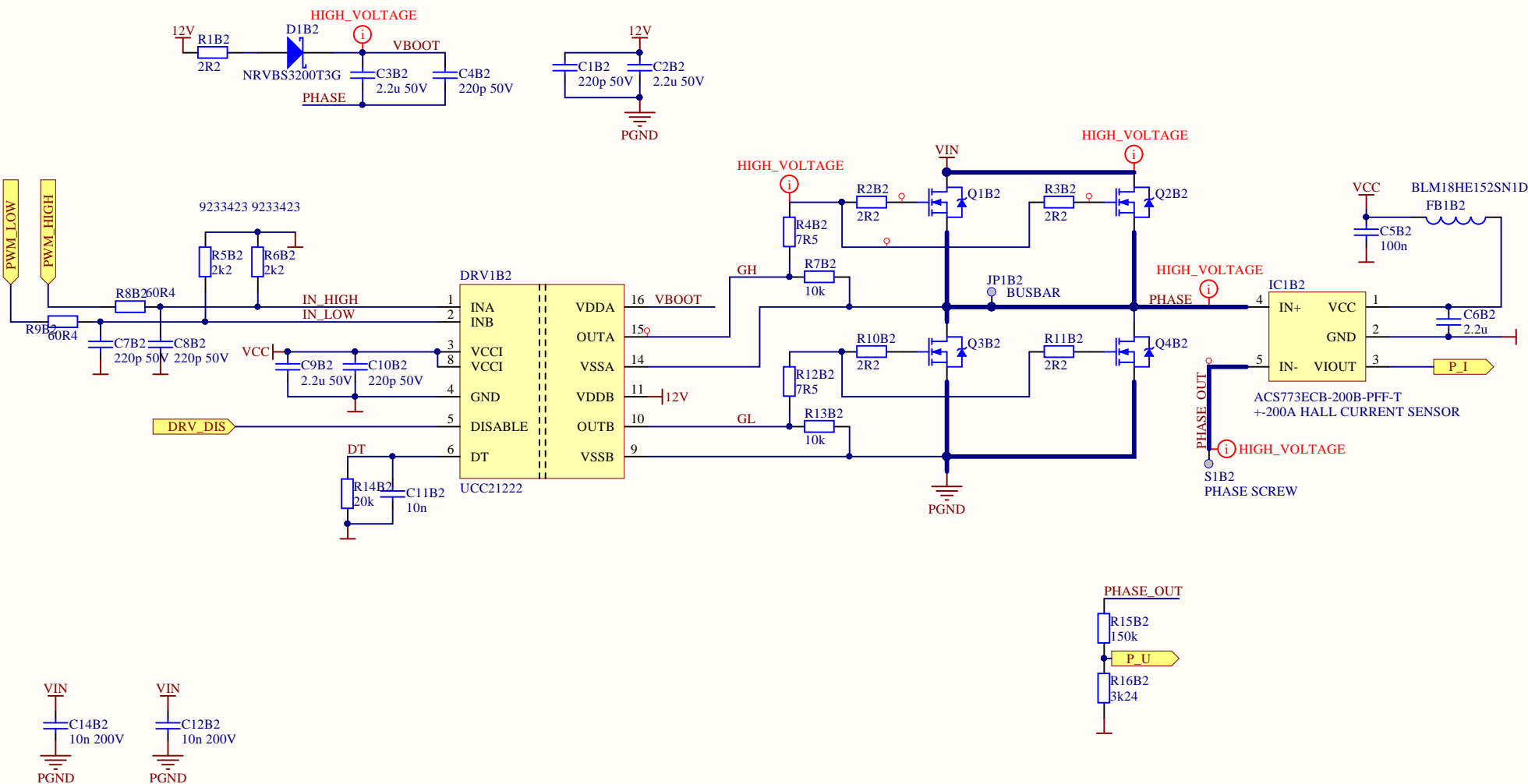
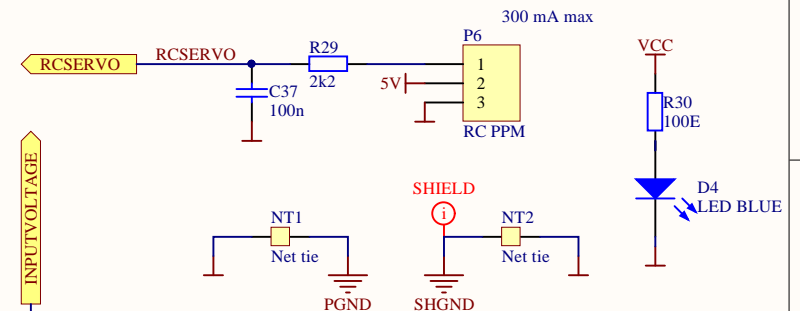
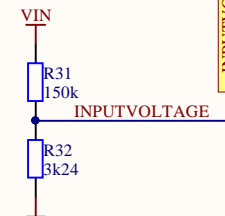
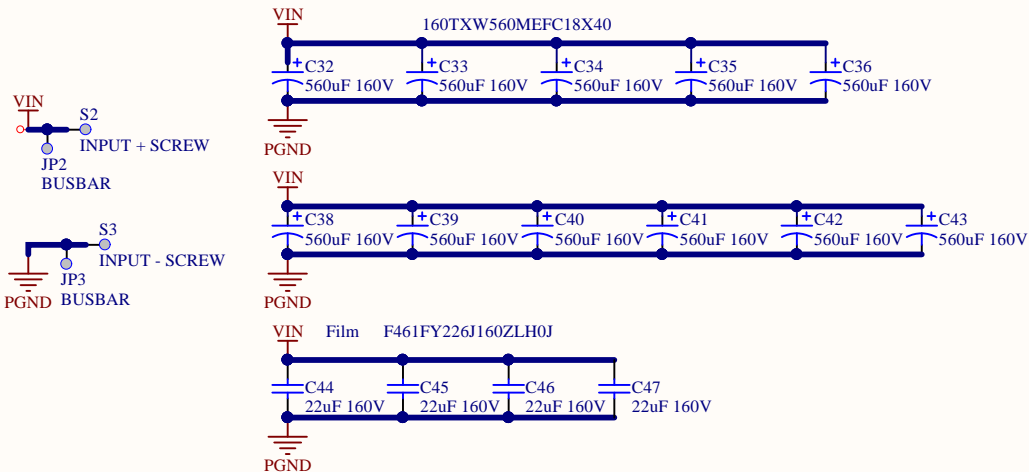
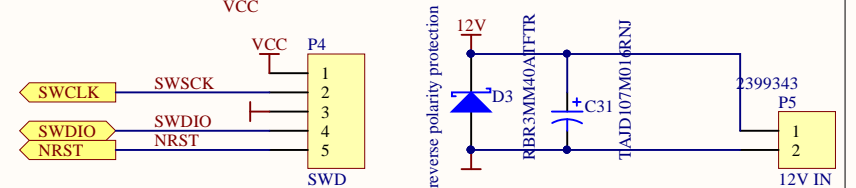
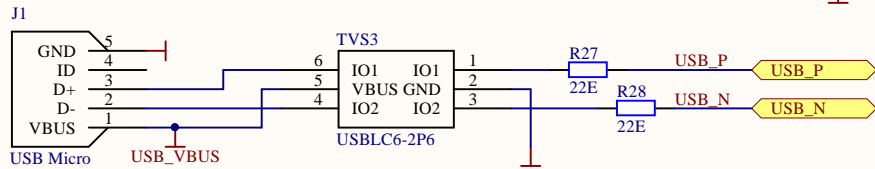
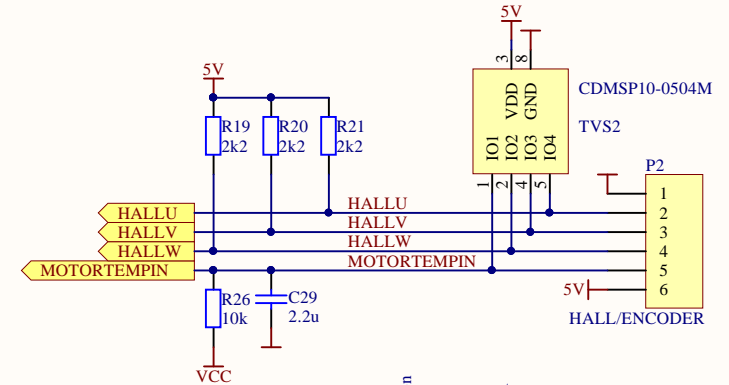
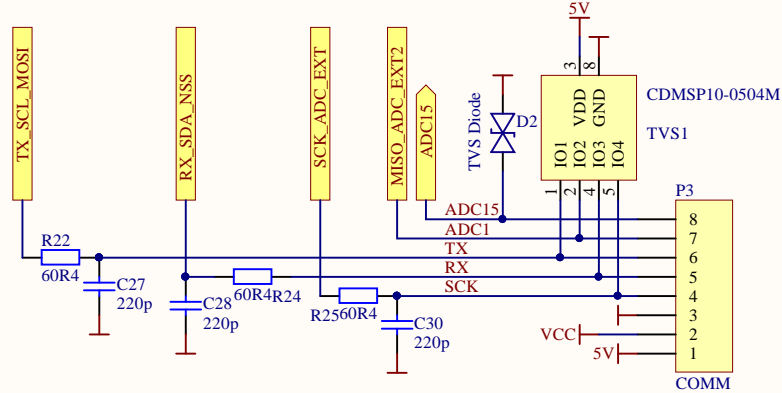
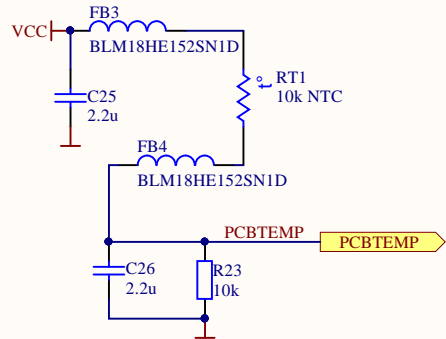
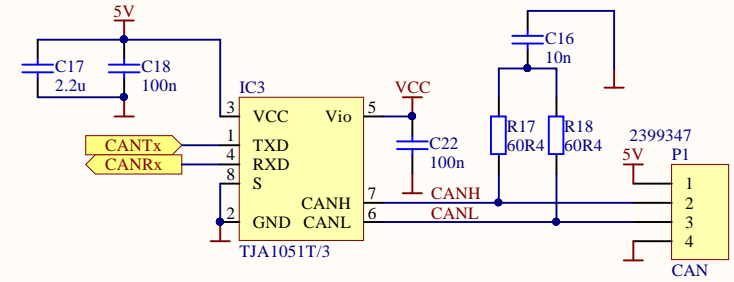
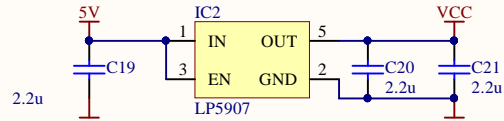
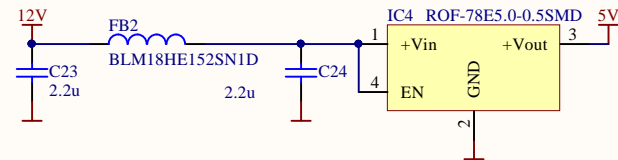


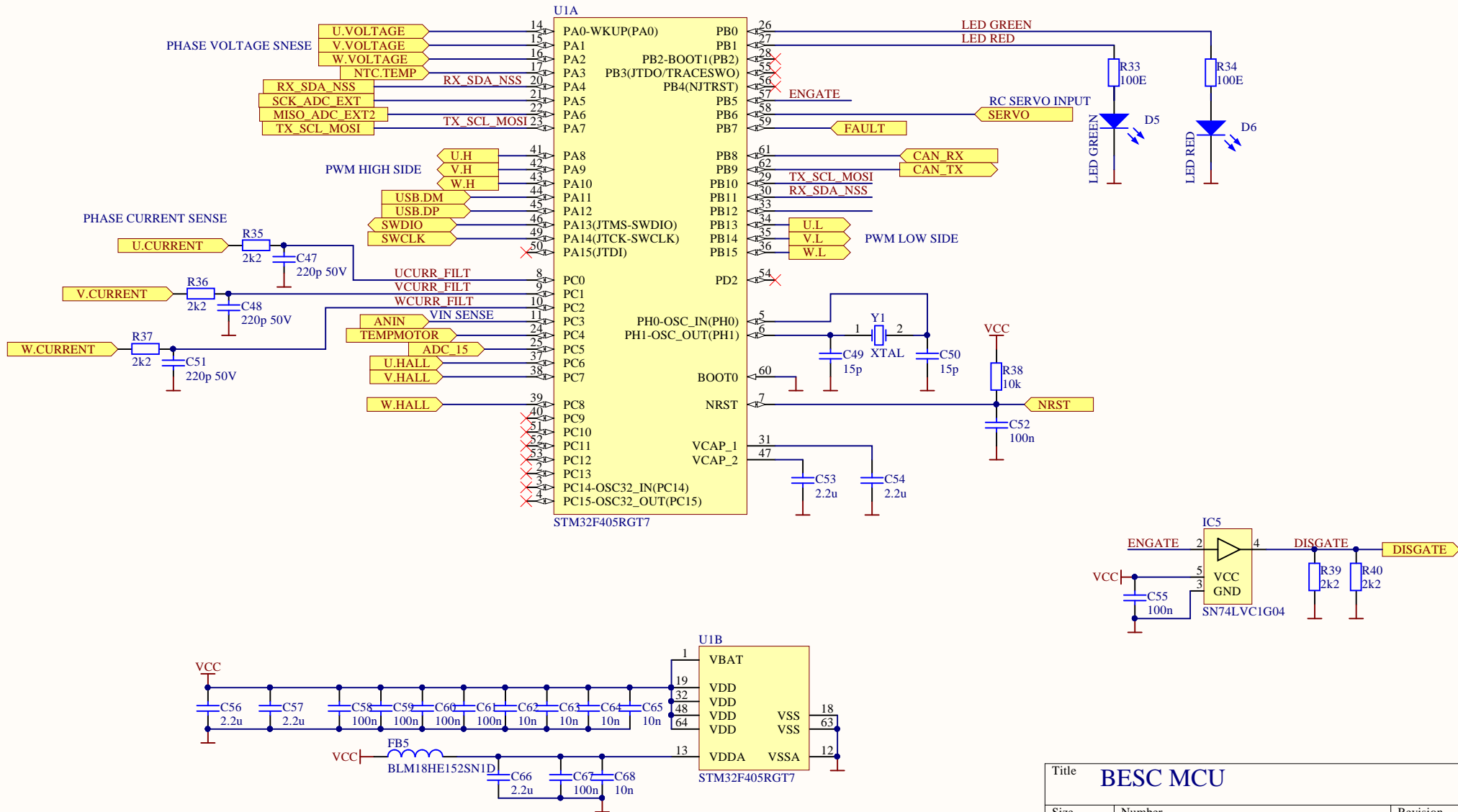
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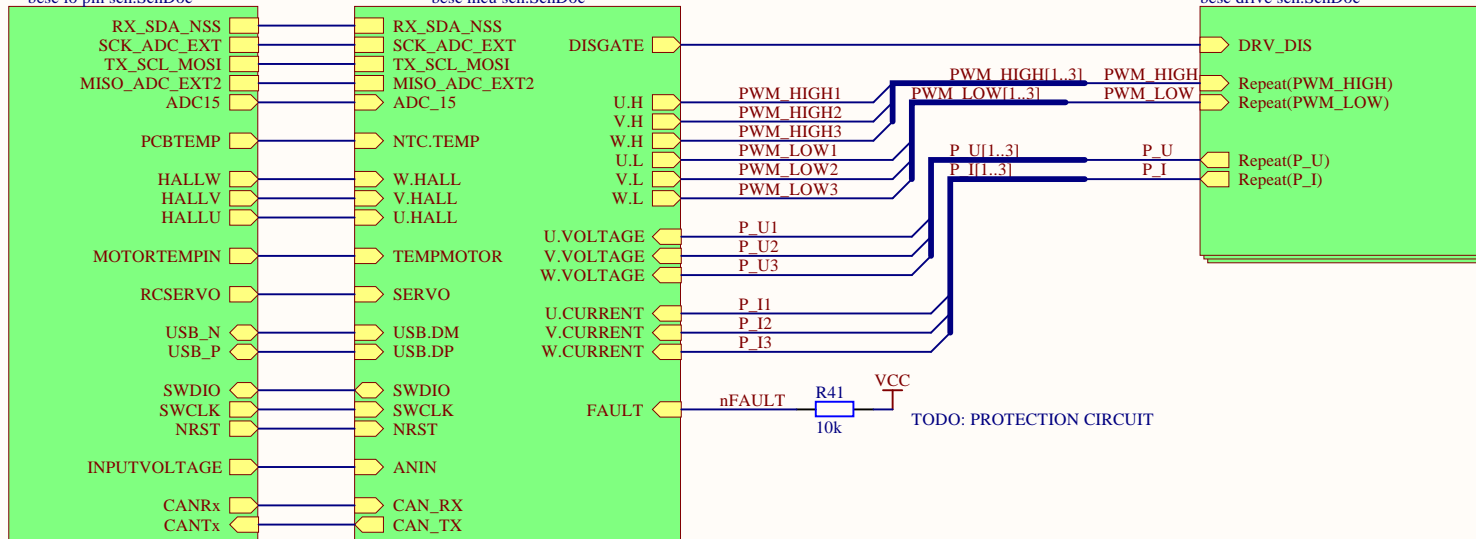


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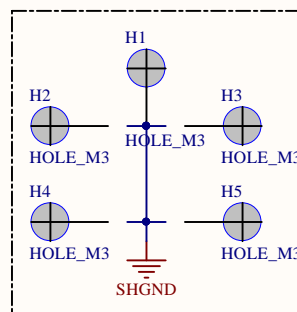
IO & POWER MANAGEMENT
besc io pm sch.SchDoc

MCU
besc mcu sch.SchDoc

Repeat(B,1,3)
besc drive sch.SchDoc



CONNECTED THROUGH HEATSINK



- zamenjaj led z kotnimi
- premakni komponente stran od konektorjev, da se lahko doda za njimi stena
- dodaj tranzistor na vin sense
- razdeli comm konektor na 3 -> uart, adc1, adc2

Title		
Size	Number	Revision
A4		
Date:	28.3.2019	Sheet of
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